

108	111	114	116	119	122	123	125	128	129	133	135	136	140	144
104	107	110	112	115	118	120	124	130	131	134	137	139	143	3
100	103	106	109	113	117	121	126	127	132	138	141	142	2	6
99	101	105										1	4	8
97	98	102										5	7	11
93	95	96										9	10	14
92	94	91										13	12	15
89	88	90										18	16	17
87	84	85										19	22	20
86	82	81										24	23	21
83	79	77										30	26	25
80	76	73										33	29	27
78	74	70	69	66	60	55	54	49	45	41	37	34	31	28
75	71	67	65	62	59	58	52	48	46	43	40	38	35	32
72	68	64	63	61	57	56	53	51	50	47	44	42	39	36

The bonding pads viewed from the top of the package are numbered counterclockwise with pad 1 being the pad closest to the dot on the corner of the package. This diagram shows the pins when viewing the package from the bottom or pin side. Pin 1 has an extra pin attached to it.

Pins 18, 19, 54, 55, 90, 91, 126, 127 are 0.15 ohm max, approximately 2.25nH max.
Pins 1, 37, 73, 109 are 0.2 ohm max, approximately 5nH max.
All others are 0.8 ohm max, approximately 9.3nH max.

Measured inductances for pairs of pins are: 1-5: 10.1nH, 9-13: 10.1nH, 18-19: 5.5nH, 26-29: 15.2nH, 31-35: 18.6nH, 39-42:18.6nH, 44-47: 16.6nH, 50-51: 10.8nH, 53-56: 14.8nH.

XEROX PARC CSL	Project Dragon	Title 144 Pin Grid Array (PinOut144.sil)	Rev B	Drawn by R. M. Barth	Date 10/20/84	Page 1 of 1
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